



Pressure sensors

Gauge pressure transducers

Series/Type: AK2 series
Ordering code:

Date: 2009-08-03
Version: 3

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Description

- The transducers are based on piezoresistive silicon pressure sensors from our own clean room.
- The robust stainless steel/plastic casing is accentuated through its excellent mechanical decoupling.

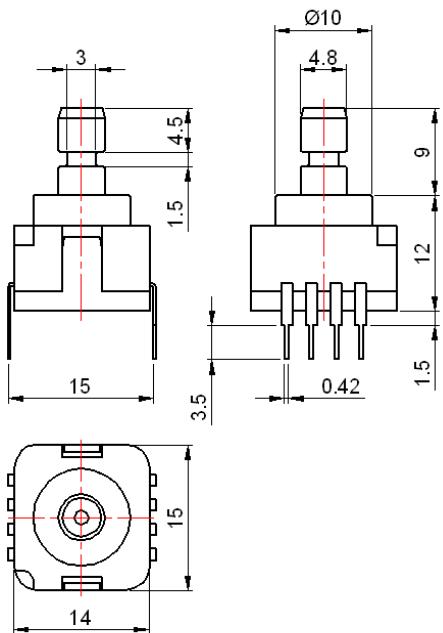
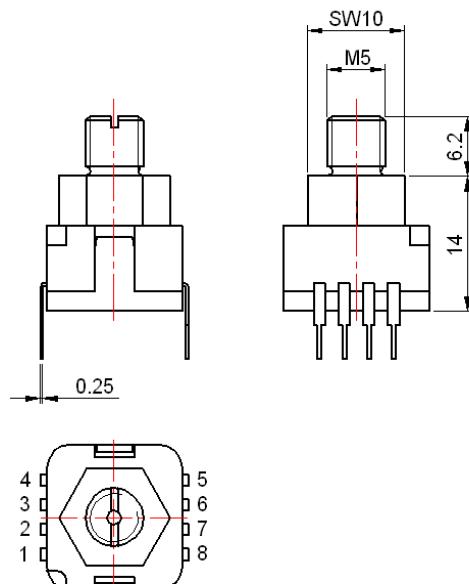


Features

- Piezoresistive MEMS technology
- Measured media:
Air, non-aggressive gases (gas humidity 0 ... 100% r.h.)
and non-aggressive fluids.
Unsuitable for substances which react with glass, silicon, stainless steel, silicone glue ($p_r \leq 10$ bar) or epoxy glue ($p_r > 10$ bar).
- Wheatstone bridge with mV output, proportional to pressure and ratiometric to supply voltage
- RoHS-compatible, halogen-free
- Dual-in-line package for PCB mounting



Dimensional drawings

Type KD (4.8 mm tube fitting)

Type KC (M5 thread connection)


All dimensions in mm

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Technical data

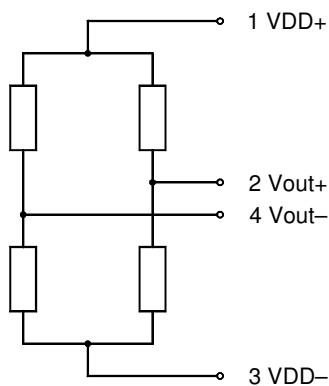
Absolute maximum ratings

Parameter	Symbol	Conditions	Min.	Typ.	Max.	Unit
Temperature ranges						
Storage temperature range	T _{st}	1)	-40		+125	°C
Operating temperature range	T _a	2)	-30		+85	°C
Soldering temperature	T _{solder}	<5 s (no reflow soldering)			+240	°C
Supply voltage /-current						
Supply voltage	V _{DD}	5)			10	V

Parameter	Symbol	Conditions	Min.	Typ.	Max.	Unit
Offset / bridge resistance @ T_a = 25 °C, V_{DD} = 5 V						
Bridge resistance	R _S	Chip type C41 (pin1-3)	4.0	5.0	6.0	kΩ
		Chip type C27 (pin1-3)	2.6	3.3	4.0	kΩ
		Chip type C28 (pin1-3)	2.7	3.2	3.7	kΩ
Offset	V ₀	6)	-25	0	+25	mV
Data in temperature range @ T_a = -30 ... 85 °C, V_{DD} = 5 V						
Temperature hysteresis		9)		±0.1	±0.5	% FS
Temperature coefficients of the bridge resistance	α _{Rs}	10)	2.1	2.4	2.7	10 ⁻³ /K
	β _{Rs}		4	6	8	10 ⁻⁶ /K ²
Temperature coefficients of the sensitivity	α _S	11)	-2.4	-2.2	-2.0	10 ⁻³ /K
	β _S		3	5	8	10 ⁻⁶ /K ²
Temperature coefficient of offset	TCV ₀	12)		±4		µV/VK

Data dependent on rated pressure @ T_a = 25 °C, V_{DD} = 5 V

Rated pressure p _r ³⁾ bar	Chip type	Sensitivity S ⁷⁾			Nonlinearity L ⁸⁾		Overpressure p _{ov} ⁴⁾ Min. bar
		Min. mV/bar	Typ. mV/bar	Max. mV/bar	Typ. % FS	Max. % FS	
0.025	C41	640	1000	1280	±1	±1.75	0.25
0.060	C41	450	700	833	±0.75	±1.5	0.35
0.100	C27	350	500	700	±0.5	±1	0.5
0.250	C27	300	400	480	±0.5	±1	0.6
0.400	C27	225	300	375	±0.5	±1	1
1.000	C27	90	120	150	±0.25	±0.5	3
2.500	C28	36	48	60	±0.25	±0.5	5
6.000	C28	15	20	25	±0.25	±0.5	9
10.00	C28	9	12	15	±0.25	±0.5	24
25.00	C28	3.6	4.8	6	±0.25	±0.5	37.5

Terminal assignment


Pin	Symbol	Terminal assignment
1	V_{DD+}	Supply voltage
2	V_{out+}	Output voltage
3	V_{DD-}	Supply voltage
4	V_{out-}	Output voltage

The polarity of V_{out} applies to positive pressure.
 Negative pressure or a reversed supply voltage
 results in a reversed polarity of the output voltage V_{out} .

Rated pressures and ordering codes

Type	Type KD		Type KC	
	Rated pressure p_r , bar	Product type	Ordering code	
B58611K1100A001	AKR 0.025 D20	0.025	B58611K1100A010	AKR 25.00 D80
B58611K1100A002	AKR 0.060 D20	0.060	B58611K1100A007	AKR 0.025 C20
B58611K1100A003	AKR 0.100 D40	0.100	B58611K1500A008	AKR 0.060 C20
B58611K1100A004	AKR 0.250 D40	0.250	B58611K1500A009	AKR 0.100 C40
B58611K1100A005	AKR 0.400 D40	0.400	B58611K1500A010	AKR 0.250 C40
B58611K1100A006	AKR 1.000 D40	1.000	B58611K1500A011	AKR 0.400 C40
B58611K1100A007	AKR 2.500 D80	2.500	B58611K1500A012	AKR 1.000 C40
B58611K1100A008	AKR 6.000 D80	6.000	B58611K1500A013	AKR 2.500 C80
B58611K1100A009	AKR 10.00 D80	10.00	B58611K1500A014	AKR 6.000 C80
			B58611K1500A015	AKR 10.00 C80
			B58611K1500A016	AKR 25.00 C80

Other rated pressures upon request.

Symbols and terms

1) Storage temperature range T_{st}

A storage of the pressure sensor within the temperature range $T_{st,min}$ up to $T_{st,max}$ and without applied pressure and supply voltage will not affect the performance of the pressure sensor.

2) Operating temperature range T_a

An operation of the pressure sensor within the temperature range $T_{a,min}$ up to $T_{a,max}$ will not affect the performance of the pressure sensor.

3) Rated pressure p_r

Within the rated pressure range 0 up to p_r the signal output characteristic corresponds to this specification.

4) Overpressure p_{ov}

Pressure cycles within the pressure range 0 up to p_{ov} will not affect the performance of the pressure sensor.

5) Supply voltage V_{DD}

$V_{DD,max}$ is the maximum permissible supply voltage, which can be applied without damages. The output voltage V_{out} is ratiometric ($V_{out} \sim V_{DD}$).

6) Offset V_0

The offset V_0 is the signal output $V_{out}(p = 0)$ at zero pressure.

7) Sensitivity S

Within the pressure range 0 up to p_r the output voltage is $V_{out}(p_x) = V_0 + S \cdot p_x$

8) Nonlinearity L (including pressure hysteresis)

The nonlinearity is the deviation of the real sensor characteristic $V_{out} = f(p)$ from the ideal straight line. It can be approximated by a polynomial of second order, with the maximum at $p_x = p_r / 2$.

The equation to calculate the nonlinearity is:

$$L = \frac{V_{out}(p_x) - V_0}{V_{out}(p_r) - V_0} - \frac{p_x}{p_r}$$

9) Temperature hysteresis

The temperature hysteresis is the change of offset, starting from the value at 25 °C after a temperature change and return to 25 °C. Determined during temperature cycles in operating temperature range (cycles with 1 K/min). (Full Scale): $FS = V_{FS} = S \cdot p_r$

10) Temperature coefficients of the bridge resistance α_{RS}, β_{RS}

Bridge resistance at temperature T_x : $R_S(T_x) = R_S(25 \text{ }^\circ\text{C}) \cdot [1 + \alpha_{RS} \cdot (T_x - 25 \text{ }^\circ\text{C}) + \beta_{RS} \cdot (T_x - 25 \text{ }^\circ\text{C})^2]$

Values are valid within the operating temperature range $T_{a,min}$ up to $T_{a,max}$

Out of the operating temperature range, the deviation may increase.

11) Temperature coefficients of the sensitivity α_S, β_S

Sensitivity at temperature T_x : $S(T_x) = S(25 \text{ }^\circ\text{C}) \cdot [1 + \alpha_S \cdot (T_x - 25 \text{ }^\circ\text{C}) + \beta_S \cdot (T_x - 25 \text{ }^\circ\text{C})^2]$

Values are valid within the operating temperature range $T_{a,min}$ up to $T_{a,max}$

Out of the operating temperature range, the deviation may increase.

12) Temperature coefficient of offset TCV_0

Offset at temperature T_x : $V_0(T_x) = V_0(25 \text{ }^\circ\text{C}) + TCV_0 \cdot (T_x - 25 \text{ }^\circ\text{C}) \cdot V_{DD}$

Values are valid within the operating temperature range $T_{a,min}$ up to $T_{a,max}$

Out of the operating temperature range, the deviation may increase.

Cautions and warnings

Storage (general)

All pressure sensors should be stored in their original packaging. They should not be placed in harmful environments such as corrosive gases nor exposed to heat or direct sunlight, which may cause deformations. Similar effects may result from extreme storage temperatures and climatic conditions. Avoid storing the sensor dies in an environment where condensation may form or in a location exposed to corrosive gases, which will adversely affect their performance. Plastic materials should not be used for wrapping/packing when storing or transporting these dies, as they may become charged. Pressure sensor dies should be used soon after opening their seal and packaging.

Operation (general)

Media compatibility with the pressure sensors must be ensured to prevent their failure. The use of other media can cause damage and malfunction. Never use pressure sensors in atmospheres containing explosive liquids or gases.

Ensure pressure equalization to the environment, if gauge pressure sensors are used. Avoid operating the pressure sensors in an environment where condensation may form or in a location exposed to corrosive gases. These environments adversely affect their performance.

If the operating pressure is not within the rated pressure range, it may change the output characteristics. This may also happen with pressure sensor dies if an incorrect mounting method is used. Be sure that the applicable pressure does not exceed the overpressure, as it may damage the pressure sensor.

Do not exceed the maximum rated supply voltage nor the rated storage temperature range, as it may damage the pressure sensor.

Temperature variations in both the ambient conditions and the media (liquid or gas) can affect the accuracy of the output signal from the pressure sensors. Be sure to check the operating temperature range and thermal error specification of the pressure sensors to determine their suitability for the application.

Connections must be wired in accordance with the terminal assignment specified in the data sheets. Care should be taken as reversed pin connections can damage the pressure transmitters or degrade their performance. Contact between the pressure sensor terminals and metals or other materials may cause errors in the output characteristics.

Design notes (dies)

This specification describes the mechanical, electrical and physical requirements of a piezoresistive sensor die for measuring pressure. The specified parameters are valid for the pressure sensor die with pressure application either to the front or back side of the diaphragm as described in the data sheet. Pressure application to the other side may result in differing data. Most of the parameters are influenced by assembly conditions. Hence these parameters and the reliability have to be specified for each specific application and tested over its temperature range by the customer.

Handling/Mounting (dies)

Pressure sensor dies should be handled appropriately and not be touched with bare hands. They should only be picked up manually by the sides using tweezers. Their top surface should never be touched with tweezers. Latex gloves should not be used for handling them, as this will inhibit the curing of the adhesive used to bond the die to the carrier. When handling, be careful to avoid cuts caused by the sharp-edged terminals. The sensor die must not be contaminated during manufacturing processes (gluing, soldering, silk-screen process).

The package of pressure sensor dies should not to be opened until the die is mounted and should be closed after use. The sensor die must not be cleaned. The sensor die must not be damaged during the assembly process (especially scratches on the diaphragm).

Soldering (transducers, transmitters)

The thermal capacity of pressure sensors is normally low, so steps should be taken to minimize the effects of external heat. High temperatures may lead to damage or changes in characteristics.

A non-corrosive type of flux resin should normally be used and complete removal of the flux is recommended. Avoid rapid cooling due to dipping in solvent. Note that the output signal may change if pressure is applied to the terminals during soldering.

This listing does not claim to be complete, but merely reflects the experience of EPCOS AG.

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The following applies to all products named in this publication:

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